ASSIGNMENT R

05 FC:8021

11-15-2005

HEET

Patents Only

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٨	To: Commissioner for Patents:	103119380		Date: November 7, 2005 Attorney Docket No. 7649-8	
	Please record the attached original documents or copy thereof.				
γ	1. Name of conveying party(ies):		2. Name and address of receiving	g party(ies):	
7	[1.] Min-Chul Sun		Samsung Electronics Co., Ltd.	. ° - =	
4	Additional name(s) of conveying party(ies) attached?	Yes X No	416 Maetan-dong, Yeongtong-gu Suwon-si, Gyeonggi-do	81.8 81.3 3.5	
	3. Nature of conveyance:		Republic of Korea		
	X_ Assignment			1129	
	Merger Security Agreement				
	Change of Name				
	Execution Date: [1.] October 26, 2005		Additional name(s) & address(es) attach	ned? Yes _X_ No	
	4. Application Serial No.	Patent No.			
	If this document is being filed together with a new application, the execution date of the application is: [1.] October 26, 2005				
l	Additional numbers attached? Yes _X No				
İ	Name and address of party to whom correspondence concerning document should be mailed: Mitchell S. Bigel Myers Bigel Sibley & Sajovec		6. Total number of applications and patents involved: 1		
			7. Total fee (37 CFR 3.41) \$40.00 X Enclosed Authorized to be charged to deposit account		
	P. O. Box 37428 Raleigh NC 27627				
		8. Deposit account number: 5		220	
	DO NOT USE THIS SPACE				
	9. Statement and signature To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. Mitchell S. Bigel, #29,614 Name of Person Signing Signature Total number of pages including cover sheet, attachments and document: 3 CERTIFICATE OF EXPRESS MAILING Express Mail Label No. EV 769244987 US Date of Deposit: November 7, 2005 I hereby certify that this correspondence is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR § 1.10 on the date indicated above and is addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450. Sugan E. Freedman				
	Date of Signature: November 7, 2005	***			
11/	11/09/2005 AKELECH1 00000025 11268131				

ASSIGNMENT

THIS ASSIGNMENT, made by me, **Min-Chul Sun**, a citizen of the Republic of Korea, residing at 1003 Jefferson Boulevard, New York 12524, USA;

WITNESSETH: That,

WHEREAS, Samsung Electronics Co., Ltd., a Korean corporation having a principal place of business at 416 Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea, hereinafter referred to as assignee, is desirous of acquiring my entire right, title and interest in and to said invention as described in said application, and in and to any and all Letters Patent which shall be granted therefor in the United States of America and all foreign countries;

NOW, THEREFORE, To Whom It May Concern, be it known that for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I have sold and by these presents do hereby sell, assign, transfer, and convey unto the said assignee, its successors and assigns, my entire right, title, and interest in and to the said invention and application, and in and to any and all continuations, continuations-in-part, or divisions thereof, and in and to any and all Letters Patent of the United States of America and all foreign countries or reissues or other forms of protection thereof which may be granted therefor or thereon, for the full end of the term for which said Letters Patent may be granted along with any term extensions thereon or therefor, together with the right to claim the priority of said application in all foreign countries in accordance with the International Convention, the same to be held and enjoyed by said assignee, its successors and assigns, as fully and entirely as the same would have been held and enjoyed by us if this assignment and sale had not been made.

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ASSIGNMENT - CONTINUED

I hereby request that said Letters Patent be issued in accordance with this assignment.

I further covenant and agree that, at the time of the execution and delivery of these presents, I possess full title to the invention and application above-mentioned, and that I have the unencumbered right and authority to make this assignment.

I further covenant and agree to promptly communicate to said assignee or its representatives any facts known to us relating to said invention, to testify in any interference or legal proceedings involving said invention, to execute any additional papers which may be requested to confirm the right of the assignee, its representatives, successors, or assigns to secure patent or similar protection for the said invention in all countries and to vest in the assignee complete title to the said invention and Letters Patent, without further compensation, but at the expense of said assignee, its successors, assigns, and other legal representatives; and I hereby instruct, and further covenant and agree to bind my heirs, legal representatives, and assigns, to do same, without further compensation, but at the expense of said assignee or its representatives.

IN WITNESS WHEREOF, I have hereunto set my hand and seal on this 26 th day of October, 2005.

Min Chul Sun (SEAL)

Min-Chul Sun

Date: 10/26/2005

RECORDED: 11/07/2005

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